54ACT16544 ... WD PACKAGE 74ACT16544 ... DL PACKAGE (TOP VIEW)

SCAS161A - AUGUST 1990 - REVISED APRIL 1996

٠	Members of the Texas Instruments
	<i>Widebus</i> ™ Family

- Inputs Are TTL-Voltage Compatible
- 3-State Inverted Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- *EPIC*[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

description

The 'ACT16544 are 16-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. Having CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-to-high transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

The 74ACT16544 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16544 is characterized for operation over the full military temperature range of –55°C to 125°C. The 74ACT16544 is characterized for operation from –40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC and Widebus are trademarks of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



1 OEAB	1	\cup		1 OEBA
1LEAB	2		55	
1CEAB	3		54	1CEBA
gnd [4		53] GND
1A1 [5		52] 1B1
1A2 🛛	6] 1B2
v _{cc} [7		50] ∨ _{CC}
1A3 🛛	8		49] 1B3
1A4 🛛	9] 1B4
1A5 🛛	10		47] 1B5
gnd [11		46	GND
1A6 [12		45	1B6
1A7 [13] 1B7
1A8 [14		43] 1B8
2A1 [15		42	2B1
2A2 🛛	16		41	2B2
2A3 🛛	17		40	2B3
gnd [18		39] GND
2A4 [19		38	2B4
2A5 🛛	20		37	2B5
2A6 🛛	21		36	2B6
v _{cc} [22		35	V _{CC}
2A7 🛛	23		34	2B7
2A8 [24		33	2B8
GND [25			GND
2CEAB	26		31	2CEBA
2LEAB	27		30	2LEBA
20EAB	28		29	20EBA
				-

54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A - AUGUST 1990 - REVISED APRIL 1996

FUNCTION TABLE[†]

	OUTPUT			
CEAB	LEAB	OEAB	Α	В
Н	Х	Х	Х	Z
L	Х	Н	Х	Z
L	Н	L	Х	в ₀ ‡
L	L	L	L	н
L	L	L	Н	L

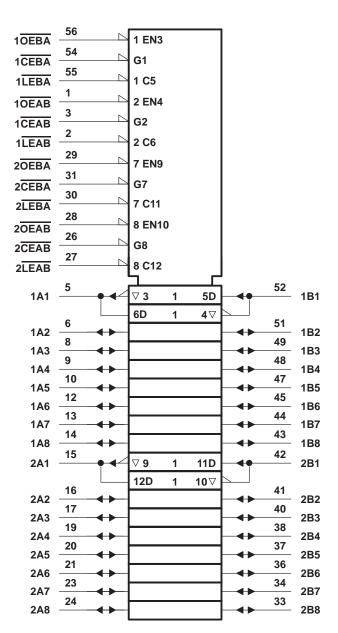
[†] A-to-B data flow is shown: <u>B-to-A flow</u> control is the same except that it uses CEBA, LEBA, and OEBA. [‡] Output level before the indicated steady-state

input conditions were established



54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A – AUGUST 1990 – REVISED APRIL 1996

logic symbol[†]

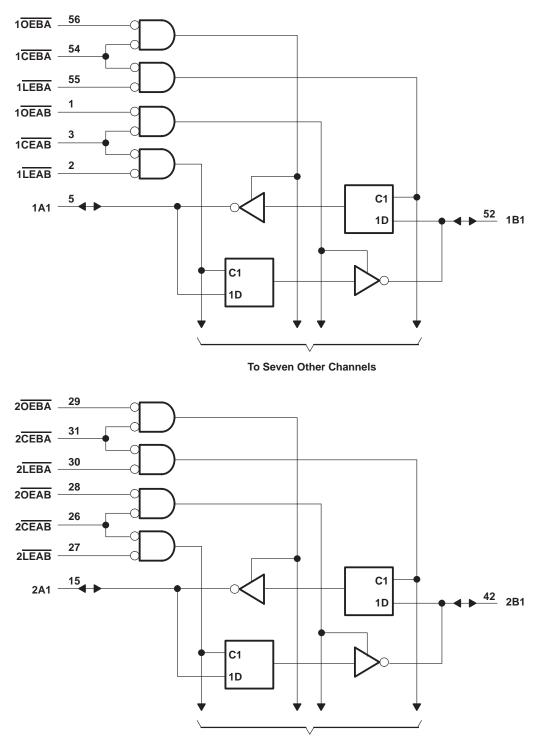


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A – AUGUST 1990 – REVISED APRIL 1996

logic diagram (positive logic)



To Seven Other Channels



SCAS161A - AUGUST 1990 - REVISED APRIL 1996

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

⁺ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 3)

		54ACT16544			74ACT16544			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2		-W	2			V
VIL	Low-level input voltage		EL.	0.8			0.8	V
VI	Input voltage	0	24	VCC	0		VCC	V
Vo	Output voltage	0	5	VCC	0		VCC	V
ЮН	High-level output current	4	20	-24			-24	mA
IOL	Low-level output current	^U U	,	24			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



SCAS161A - AUGUST 1990 - REVISED APRIL 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER				T _A = 25°C		54ACT16544		74ACT16544				
		TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			4.5 V	4.4			4.4		4.4		1	
		I _{OH} = -50 μA	5.5 V	5.4			5.4		5.4			
∨он			4.5 V	3.94			3.8		3.8		V	
		I _{OH} = -24 mA	5.5 V	4.94			4.8		4.8			
		I _{OH} = -75 mA [†]	5.5 V				3.85	N.	3.85			
		L 50 A	4.5 V			0.1		0.1		0.1		
		I _{OL} = 50 μA	5.5 V			0.1		0.1		0.1	V	
VOL			4.5 V			0.36	5	0.44		0.44		
-		I _{OL} = 24 mA	5.5 V			0.36	00	0.44		0.44	1	
		I _{OL} = 75 mA [†]	5.5 V				^A O	1.65		1.65		
Ιį	Control inputs	$V_I = V_{CC}$ or GND	5.5 V			±0.1	Y	±1		±1	μΑ	
loz‡	A or B ports	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±5		±5	μΑ	
ICC	•	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		80		80	μΑ	
∆ICC§		One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			0.9		1		1	mA	
Ci	Control inputs	V _I = V _{CC} or GND	5 V		4.5						pF	
Cio	A or B ports	$V_{O} = V_{CC}$ or GND	5 V		12						pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡] For I/O ports, the parameter I_{OZ} includes the input leakage current.

§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 25°C		T _A = 25°C 54ACT16544		74ACT16544		
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
tw	Pulse duration	LEAB or LEBA low	5.5		5.5	~	5.5		ns
		Data before LEAB or LEBA↑	1.5		1.5	N.N	1.5		ns
t _{su}	Setup time	Data before CEAB or CEBA↑	1.5		1.5	N	1.5		
		Data after LEAB or LEBA↑	3		3		3		
^t h	Hold time	Data after CEAB or CEBA↑	3		3		3		ns



SCAS161A - AUGUST 1990 - REVISED APRIL 1996

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

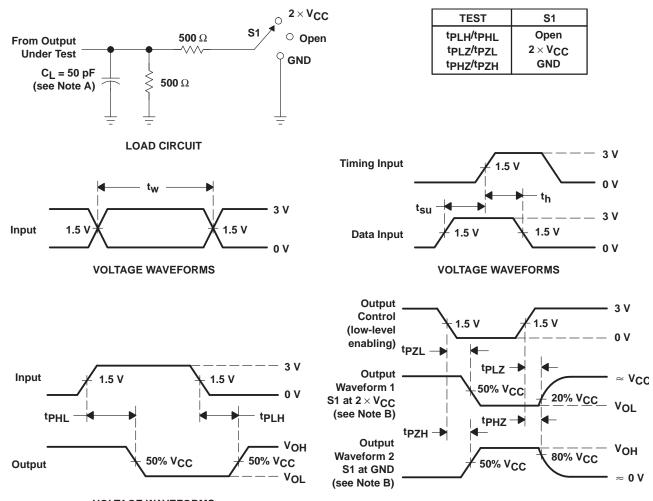
00		/ (-							
	FROM TO		T _A = 25°C		54ACT16544		74ACT16544			
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A as D	DerA	2.8	6.7	10	2.8	11.2	2.8	11.2	
^t PHL	A or B	B or A	4	7.5	10	4	11.2	4	11.2	ns
^t PLH	LEBA or LEAB	A an D	2.7	9	13.3	2.7	14	2.7	14	
^t PHL		A or B	2.8	8.5	12.1	2.8	13.5	2.8	13.5	ns
^t PZH	CEBA or CEAB		3.2	7.2	10.5	3.2	2 11.7	3.2	11.7	
^t PZL		A or B	3.8	8.2	12	3.8	13.6	3.8	13.6	ns
^t PHZ		A an D	5.8	8.2	10.3	5.8	11.1	5.8	11.1	
^t PLZ	CEBA or CEAB	A or B	5	7.4	9.4	05	10.2	5	10.2	ns
^t PZH		A an D	2.8	6.9	10.2	2 2.8	11.4	2.8	11.4	
^t PZL	OEBA or OEAB	OEBA or OEAB A or B	3.6	7.9	11.7	3.6	13.3	3.6	13.3	ns
^t PHZ		A an D	5.2	7.7	9.8	5.2	10.5	5.2	10.5	
^t PLZ	OEBA or OEAB	A or B	3.4	6.8	8.8	3.4	9.6	3.4	9.6	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER			TEST CO	TYP	UNIT	
		Outputs enabled	0. 50 - 5	6 4 MUL	60	
Cpd		Outputs disabled	C _L = 50 pF,	f = 1 MHz	13	р⊢



SCAS161A - AUGUST 1990 - REVISED APRIL 1996



PARAMETER MEASUREMENT INFORMATION

VOLTAGE WAVEFORMS

VOLTAGE WAVEFORMS

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Broadband	www.ti.com/broadband
DSP	dsp.ti.com	Digital Control	www.ti.com/digitalcontrol
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Military	www.ti.com/military
Logic	logic.ti.com	Optical Networking	www.ti.com/opticalnetwork
Power Mgmt	power.ti.com	Security	www.ti.com/security
Microcontrollers	microcontroller.ti.com	Telephony	www.ti.com/telephony
RFID	www.ti-rfid.com	Video & Imaging	www.ti.com/video
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2009, Texas Instruments Incorporated